

DATA SHEET

# SKY66104-11: 1787 to 1930 MHz High-Power RF Front-End Module

## Applications

- Cordless phone wireless headsets
- Cordless phone base station/handsets
- Unified communications systems

## Features

- Integrated PA with up to +25 dBm output power
- Single-ended, 50 Ω transmit/receive RF interfaces
- Fast turn-on/turn-off time: < 5 μs
- Supply operation: 3.0 V to 4.5 V
- Sleep mode current: < 5 μA
- Small footprint MCM (24-pin, 4 x 4 mm) package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

## Description

The SKY66104-11 is a high performance, highly integrated RF Front-End Module (FEM) designed for Digitally Enhanced Cordless Telecommunication (DECT) applications operating in the 1880 MHz to 1930 MHz frequency band, and extended applications for the 1787 MHz to 1792 MHz band.

The SKY66104-11 is designed for ease of use and maximum flexibility, with fully matched 50 Ω inputs and outputs, and digital controls compatible with 1.4 V to 3 V CMOS levels. An external Output Matching Network (OMN) between the PA output and the antenna switch provides ultimate flexibility in DECT applications.

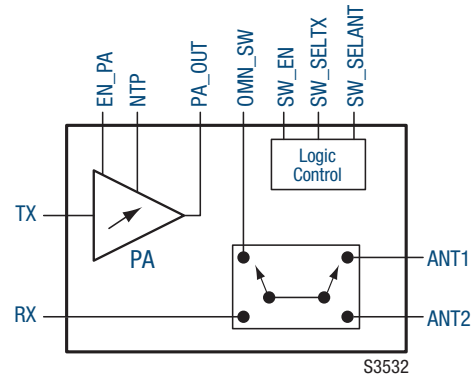


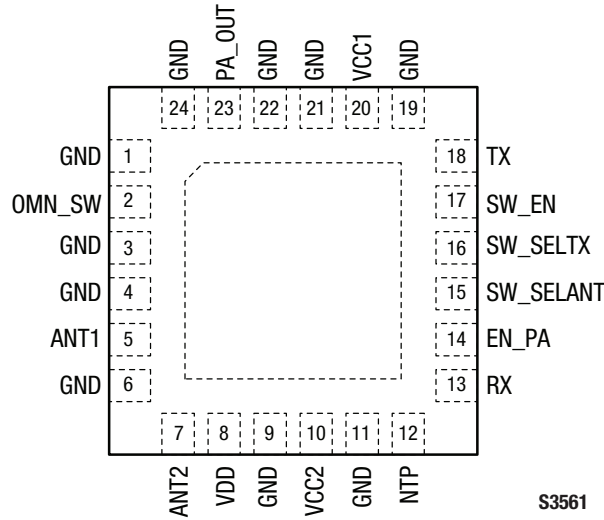
Figure 1. SKY66104-11 FEM Block Diagram

A Normal Transmit Power (NTP) input is used to control power between -10 dBm and +25 dBm. NTP is a voltage-operated control with a very high input impedance (>100 kΩ) and a range of 0 V to 1.8 V.

The RF blocks operate over a wide supply voltage range from 3.0 V to 4.5 V, which allows the SKY66104-11 to be used in battery powered applications over a wide spectrum of the battery discharge curve.

The SKY66104-11 is packaged in a 24-pin, 4 x 4 mm Multi-Chip Module (MCM), which allows for a highly manufacturable low-cost solution.

A functional block diagram of the SKY66104-11 is shown in Figure 1. The 24-pin MCM package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



**Figure 2. SKY66104-11 Pinout – 24-Pin MCM (Top View)**

**Table 1. SKY66104-11 Signal Descriptions**

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	13	RX	Receive output port (from switch)
2	OMN_SW	Transmit post-OMN input to switch	14	EN_PA	PA enable
3	GND	Ground	15	SW_SELANT	Switch logic control, ANT1/ANT2 select
4	GND	Ground	16	SW_SELTX	Switch logic control, TX/RX select
5	ANT1	Antenna 1 port	17	SW_EN	Switch logic control, switch enable
6	GND	Ground	18	TX	Transmit input port (to PA)
7	ANT2	Antenna 2 port	19	GND	Ground
8	VDD	Supply, switch	20	VCC1	Supply, PA bias
9	GND	Ground	21	GND	Ground
10	VCC2	Supply, PA collector and NTP controller	22	GND	Ground
11	GND	Ground	23	PA_OUT	PA output port (to external OMN)
12	NTP	Normal Transmit Power adjustment	24	GND	Ground

### Technical Description

The SKY66104-11 contains all of the needed RF matching and DC biasing circuits. The PA is a two-stage, HBT InGaP device optimized for high linearity and power efficiency. The PA output power is controlled by a silicon device.

These features make the device suitable for wideband digital applications where PA linearity and power consumption are of critical importance.

The device is designed for standard DECT applications. Under these stringent test conditions, the device exhibits excellent spectral purity and power efficiency.

### Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY66104-11 are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 through 7.

The state of the SKY66104-11 is determined by the logic provided in Table 8. Mode control configurations are noted in Table 9.

A plot of output power versus NTP is shown in Figure 3.

**Table 2. SKY66104-11 Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage (VCC1, VCC2, VDD)	VPS	-0.3	+4.8	V
Logic control voltages	V <sub>IH</sub> , V <sub>IL</sub>	-0.3	+3.3	V
Transmit RF input power (at TX port)	P <sub>IN_TX</sub>		+10	dBm
Receive RF input power (at ANT1 or ANT2 ports)	P <sub>IN_RX</sub>		+20	dBm
Voltage standing wave ratio	VSWR		6:1	-
Operating case temperature (Note 2)	T <sub>c</sub>	-40	+85	°C
Storage temperature	T <sub>STG</sub>	-55	+150	°C
Electrostatic discharge: Human Body Model (HBM), Class 1A	ESD		250	V

**Note 1:** Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their typical value as provided in Tables 3, 4, and 5. Exceeding any of the limits listed here may result in permanent damage to the device.

**Note 2:** Nominal junction-to-case thermal resistance is 80°C/W.

**CAUTION:** Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

**Table 3. SKY66104-11 Recommended Operating Conditions**

Parameter	Symbol	Minimum	Typical	Maximum	Units
Operating case temperature (Note 1)	T <sub>c</sub>	-40	+25	+80	°C
RF supply voltage (Note 2)	VCC1, VCC2	3.0	3.6	4.5	V
Switch supply voltage (Note 2)	VDD	3.0	3.6	4.5	V

**Note 1:** Specified case temperature is measured at the MCM ground pad interface.

**Note 2:** Power supply pins VCC1, VCC2, and VDD are independent supplies and are not internally tied together.

**Table 4. SKY66104-11 DC Electrical Specifications (Note 1)**

**(VCC1/2 = +3.6 V, VDD = 3.6 V, T<sub>c</sub> = +25 °C, P<sub>IN</sub> = 0 dBm, as Measured on the SKY66104-11 Evaluation Board (De-Embedded to Device), Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Total supply current in Transmit Mode (Note 2)	I <sub>PS(TX24)</sub>	P <sub>OUT</sub> = +24 dBm		171		mA
	I <sub>PS(TX15)</sub>	P <sub>OUT</sub> = +15 dBm		83		mA
	I <sub>PS(TX10)</sub>	P <sub>OUT</sub> = +10 dBm		58		mA
Total supply current in Receive Mode (Note 2) (Note 3)	I <sub>PS(RX)</sub>			60		μA
Total supply current in Sleep Mode (Note 2) (Note 3)	I <sub>PS(OFF)</sub>			4.1		μA
NTP input current in Transmit Mode (Note 3)	I <sub>NTP_IN</sub>			9.5		μA

**Note 1:** Performance is guaranteed only under the conditions listed in this Table. Receive (RX), Transmit (TX), and Sleep Mode configurations are defined in Table 9. Typical performance shown is for Engineering Sample 2 (ES2).

**Note 2:** I<sub>PS</sub> = I<sub>CC1</sub> + I<sub>CC2</sub> + I<sub>DD</sub>. These are expected total power supply currents for indicated P<sub>OUT</sub> at ANT1/2 ports.

**Note 3:** NTP = 0 V.

**Table 5. SKY66104-11 Transmit Mode Electrical Specifications (Note 1) (Note 2)**  
**(VCC1/2 = +3.6 V, VDD = 3.6 V, Tc = +25 °C, P<sub>IN</sub> = 0 dBm, as Measured on the SKY66104-11 Evaluation Board (De-Embedded to Device), All Used and Unused Ports Terminated with 50 Ω, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Frequency range (Note 3)	f		1880		1930	MHz
Output power at ANT1/2 ports (Note 4)	P <sub>OUT</sub>	NTP ≥ 1.55 V NTP ≤ 0.3 V		+24 +0		dBm dBm
Output power variation over temperature (Note 4) (Note 5)	P <sub>OUT-TV</sub>	T <sub>C</sub> = -40 °C to +85 °C, relative to the value at 25 °C	-2	-0.9/+0.8	+2	dB
NTP input voltage (Note 4)	NTP	P <sub>OUT</sub> = +15 dB P <sub>OUT</sub> = +10 dB		0.7 0.5		V V
Small signal gain	S <sub>21</sub>	P <sub>IN</sub> = -25 dBm, NTP = 1.8 V		+27		dB
TX-RX port isolation	S <sub>21TX-RX</sub>	Pin 13 relative to pin 18		5		dB
Ant-RX port isolation	S <sub>21ANT-RX</sub>	Pin 13 relative to pin 5 or 7		29		dB
Input return loss	S <sub>11</sub>	@ TX port		-12	-7	dB
Output return loss	S <sub>22</sub>			-12	-8	dB
1 dB output compression point (Note 6)	OP1dB	NTP = 1.8 V		+24		dBm
2 <sup>nd</sup> and 3 <sup>rd</sup> harmonics	2fo, 3fo	NTP = 1.8 V, CW		-50	-30	dBc
Higher harmonics (Note 5)	4fo to 10 fo	NTP = 1.8 V, CW		-50	-40	dBc
Turn-on time (Note 5)	t <sub>ON</sub>	From 50% of rising logic control to 90% of final RF output power		1.6	5	μs
Turn-off time (Note 5)	t <sub>OFF</sub>	From 50% of falling logic control to 10% of final RF output power		0.3	5	μs
Stability (Note 5)	Stab	NTP = 1.8 V, CW f = 0.1 GHz to 20 GHz, load VSWR = 6:1	All non-harmonically related outputs < -40 dBm			
Ruggedness (Note 5)	RU	NTP = 1.8 V, CW load VSWR = 6:1	No permanent damage			

**Note 1:** Performance is guaranteed only under the conditions listed in this Table. Production testing is performed at 1905 MHz. Transmit (TX) Mode configuration is defined in Table 9. Typical performance shown is for Engineering Sample 2 (ES2).

**Note 2:** With specified matching network between pins PA\_OUT and OMN\_SW. P<sub>OUT</sub> measured at ANT1/ANT2 ports.

**Note 3:** f = 1787 MHz to 1880 MHz at reduced performance with P<sub>OUT</sub> = +20 dBm.

**Note 4:** NTP is an analog input control. See Figure 3 for typical characteristics.

**Note 5:** Not tested in production. Fully characterized and guaranteed by design.

**Note 6:** Starting point for test is P<sub>IN</sub> = -13 dBm.

**Table 6. SKY66104-11 Receive Mode Electrical Specifications (Note 1)**  
**(VCC1/2 = +3.6 V, VDD = 3.6 V, Tc = +25 °C, ANT1 and ANT2 Ports, as Measured on the SKY66104-11 Evaluation Board (De-Embedded to Device), All Used and Unused Ports Terminated with 50 Ω, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Frequency range (Note 2)	f		1880		1930	MHz
Receive loss	RX_LOSS			0.8		dB
ANT1/2 port input return loss	S11 <sub>ANT1/2</sub>			-12	-8	dB
RX port output return loss	S22 <sub>RX</sub>			-12	-8	dB
Turn-on time (Note 3)	t <sub>ON</sub>	From 50% of falling logic control to 90% of final RF output power		1.6	5	μs
Turn-off time (Note 3)	t <sub>OFF</sub>	From 50% of rising logic control to 10% of final RF output power		0.3	5	μs

**Note 1:** Performance is guaranteed only under the conditions listed in this table. Production testing is performed at 1905 MHz. Receive (RX) Mode configuration is defined in Table 9.

**Note 2:** f = 1787 MHz to 1792 MHz at reduced performance.

**Note 3:** Not tested in production. Fully characterized and guaranteed by design.

**Table 7. SKY66104-11 Diversity Antenna Electrical Specifications (Note 1)**  
**(VCC1/2 = +3.6 V, VDD = 3.6 V, Tc = +25 °C, as Measured on the SKY66104-11 Evaluation Board (De-Embedded to Device), All Unused Ports Terminated with 50 Ω, Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Isolation, ANT1 to ANT2	ISOL <sub>ANTSW</sub>	Transmit (TX) Mode		29		dB
Isolation, ANT(x) to RX	ISOL <sub>ANT-RX</sub>	Transmit (TX) Mode		29		dB
ANT1 to ANT2 switching time in Transmit Mode (Note 2)	t <sub>ANT1_ANT2(TX)</sub>	Transmit (TX) Mode		1.6	5	μs
ANT1 to ANT2 switching time in Receive Mode (Note 2)	t <sub>ANT1_ANT2(RX)</sub>	Receive (RX) Mode		0.3	5	μs

**Note 1:** Performance is guaranteed only under the conditions listed in this Table. Receive (RX) Mode and Transmit (TX) Mode configurations are defined in Table 9.

**Note 2:** Not tested in production. Fully characterized and guaranteed by design.

**Table 8. SKY66104-11 Electrical Specifications: Control Logic Characteristics (Note 1)**  
**(Tc = +25 °C, as Measured on the SKY66104-11 Evaluation Board (De-Embedded to Device), Unless Otherwise Noted)**

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Control voltage:						
High	V <sub>IH</sub>		1.4	1.7	3.3	V
Low	V <sub>IL</sub>		0		0.3	V
Input current:						
High (Note 2)	I <sub>IH</sub>			24		μA
Low (Note 3)	I <sub>IL</sub>			0		μA

**Note 1:** Performance is guaranteed only under the conditions listed in this table. Control logic input signals are: SW\_EN, SW\_SELTX, and SW\_SELANT.

**Note 2:** With required internal pull-down of 72 kΩ, typical I<sub>IH</sub> condition is V<sub>IH</sub> = 1.7 V.

**Note 3:** Typical I<sub>IL</sub> condition is V<sub>IL</sub> = 0 V.

**Table 9. SKY66104-11 Mode Control Logic (Note 1)**

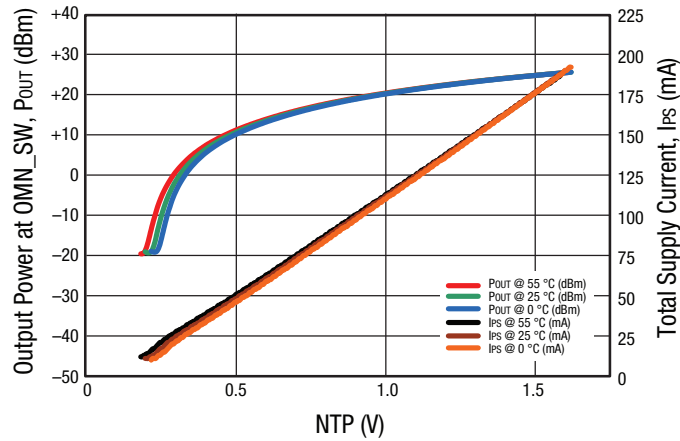
Mode	EN_PA (Note 2) (Pin 14)	SW_SELANT (Pin 15)	SW_SELTX (Pin 16)	SW_EN (Pin 17)	Total Current
TX → ANT1	1	1	1	1	72 mA
TX → ANT2	1	0	1	1	72 mA
RX → ANT1 (Note 3)	0	1	0	1	60 μA
RX → ANT2 (Note 3)	0	0	0	1	60 μA
Sleep (Note 3) (Note 4)	0	0	0	0	4.1 μA

**Note 1:** Logic levels “0” and “1” are compliant with  $V_{IL}$  and  $V_{IH}$ , respectively, as specified in Table 8.

**Note 2:** EN\_PA is exclusively used to power up/down the PA. This signal is not involved with configuring the switches. The EN\_PA states shown in this table are what is needed to achieve the desired receive and transmit functionality and performance.

**Note 3:** The transmit PA is turned off in this mode for minimum power consumption.

**Note 4:** NTP at 0 V.



**Figure 3. SKY66104-11 NTP Control vs Output Power (TX Mode, V<sub>ps</sub> = 3.6 V, f = 1905 MHz, P<sub>in</sub> = 0 dBm)**

**Evaluation Board Description**

The SKY66104-11 Evaluation Board is used to test the performance of the SKY66104-11 FEM. A typical application schematic diagram is provided in Figure 4. An assembly drawing for the Evaluation Board is shown in Figure 5. An Evaluation Board schematic is shown in Figure 6, and the layer detail is provided in Figure 7.

**Package Dimensions**

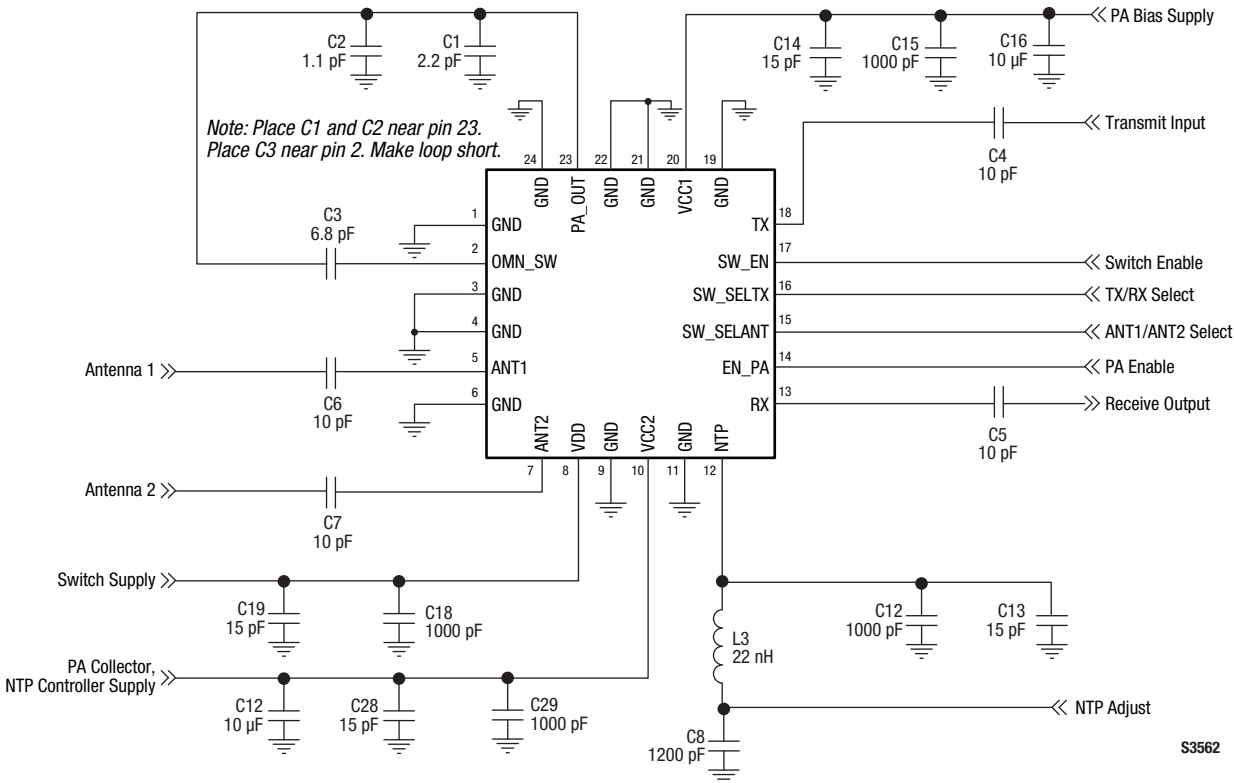
Typical part markings are shown in Figure 8. The PCB layout footprint for the SKY66104-11 is provided in Figure 9. Figure 10 shows the package dimensions for the 24-pin MCM, and Figure 11 provides the tape and reel dimensions.

**Package and Handling Information**

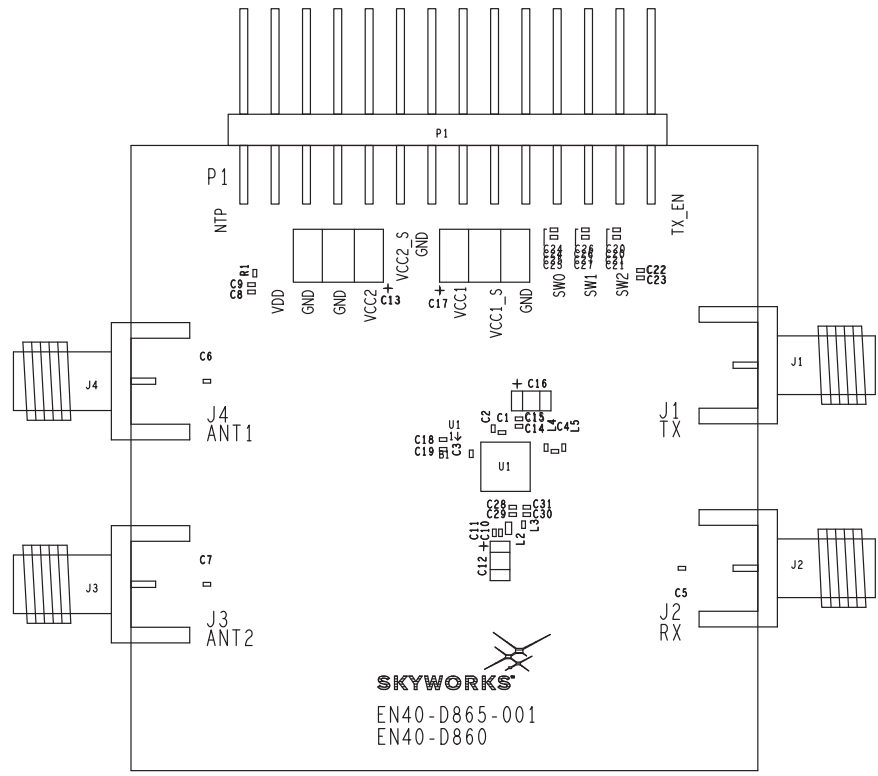
Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY66104-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



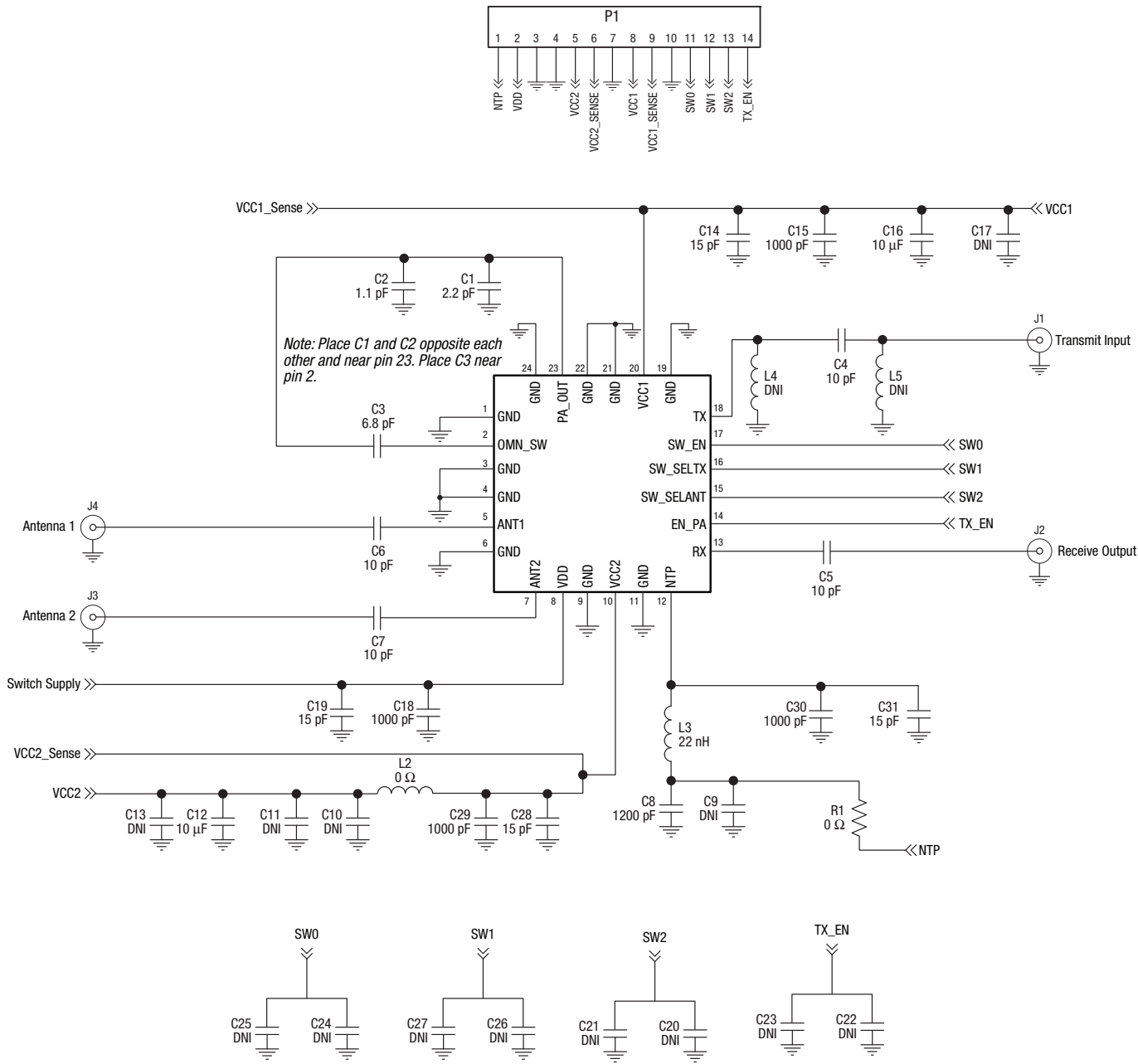
**Figure 4. SKY66104-11 Typical Application Schematic**



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Figure 5. SKY66104-11 Evaluation Board Assembly Drawing

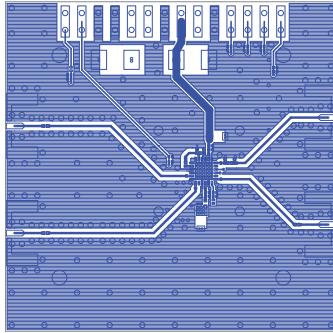




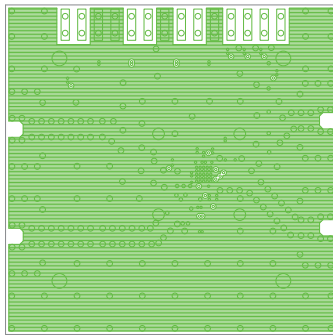
Note: Some component labels may be different than the corresponding component symbol shown here. Component values, however, are accurate as of the date of this Data Sheet.

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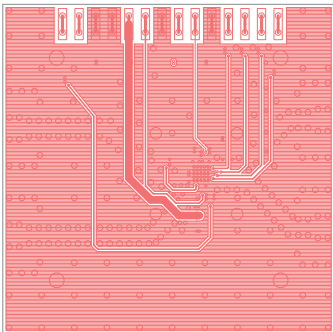
Figure 6. SKY66104-11 Evaluation Board Schematic



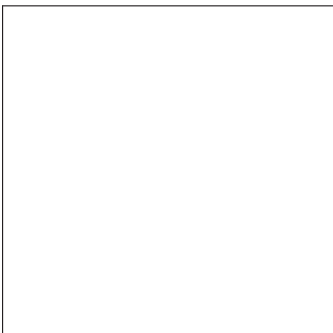
Layer 1: Top Layer



Layer 2: Ground Plane



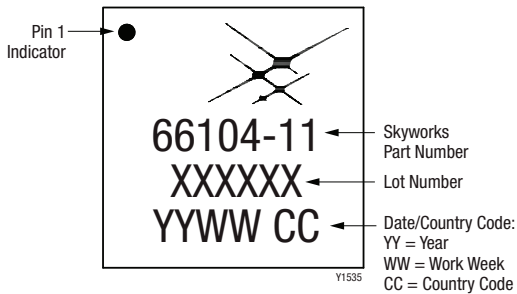
Layer 3: VCC Layer



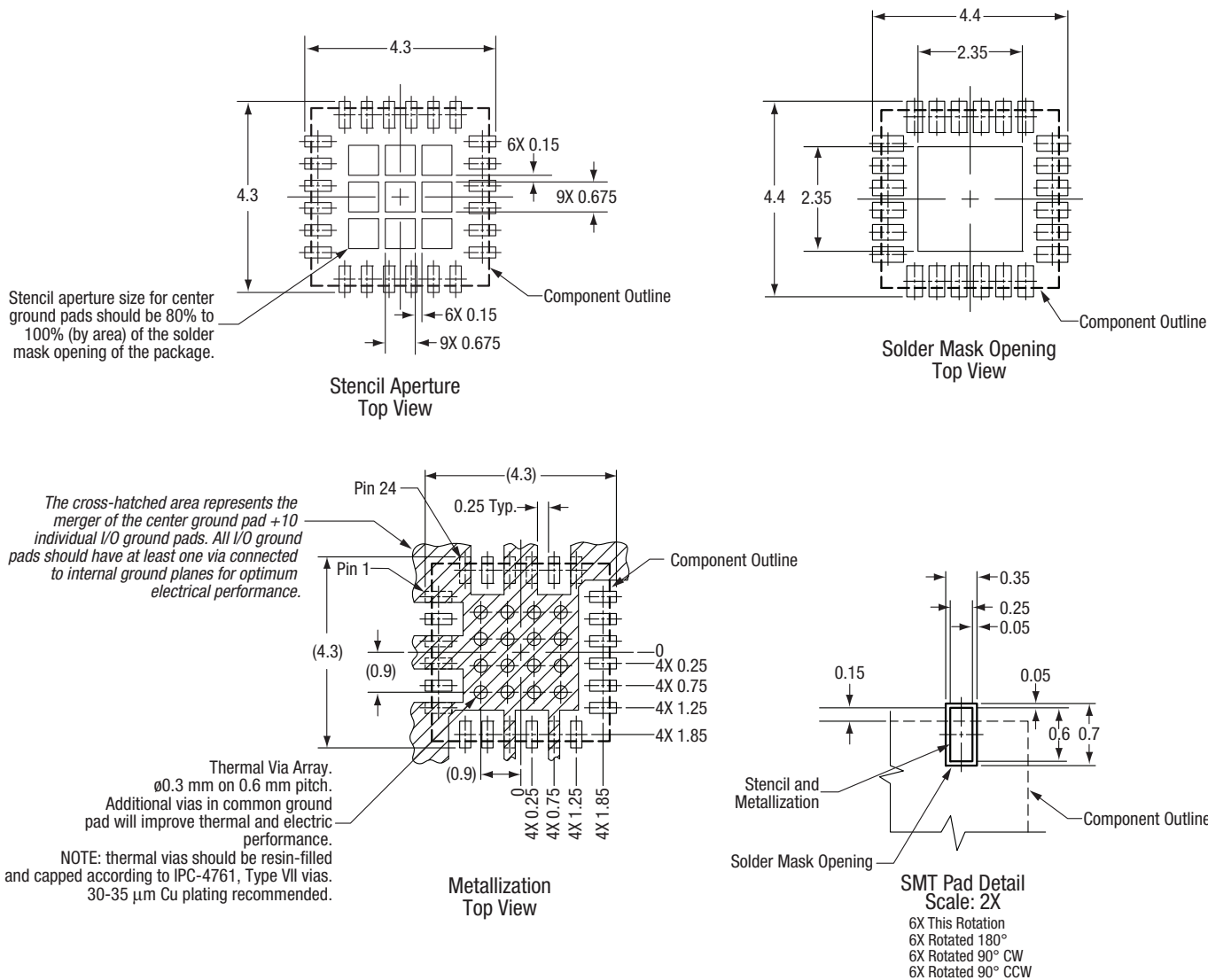
Layer 4: Bottom Layer

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**Figure 7. Evaluation Board Layer Detail**



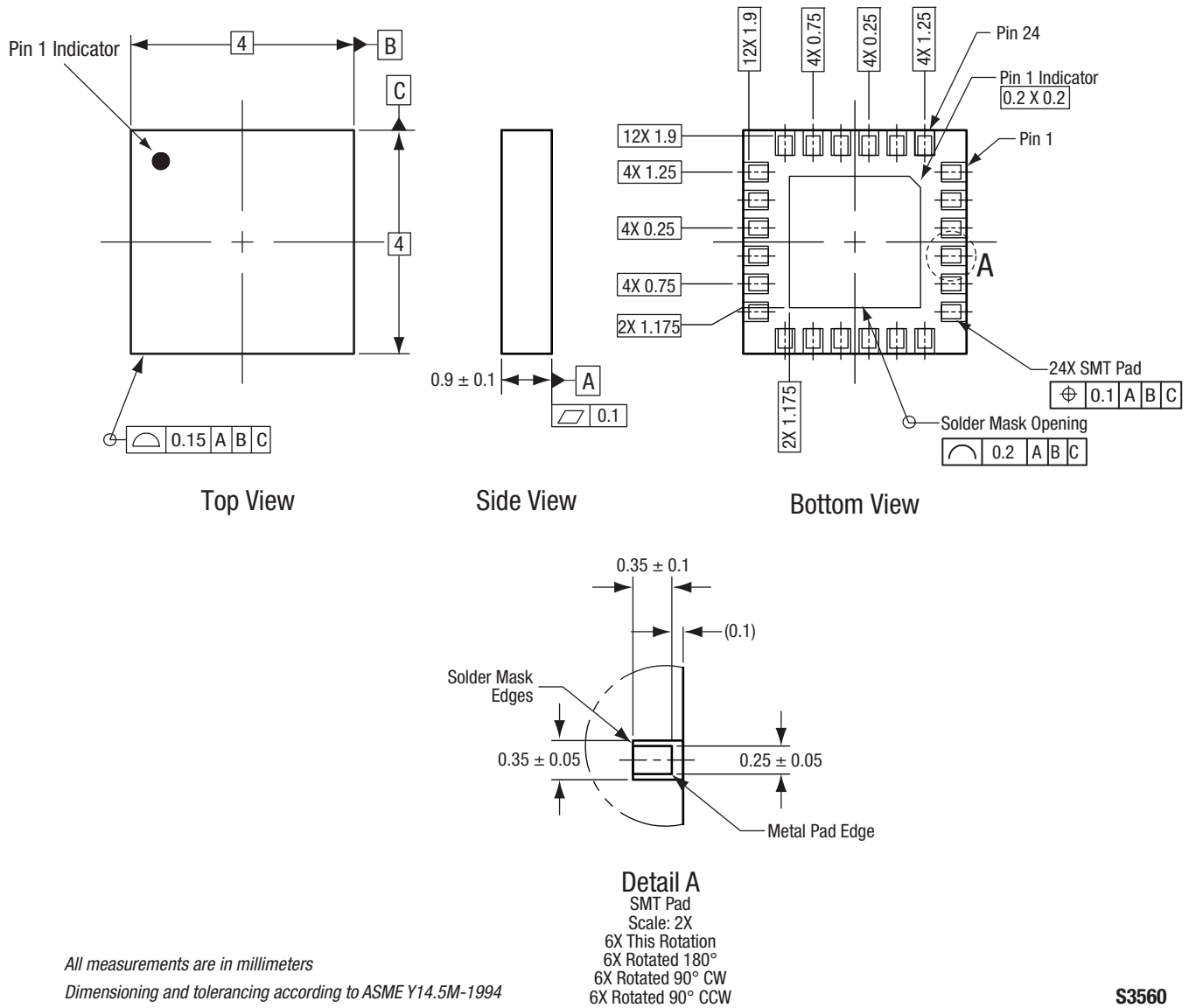
**Figure 8. Typical Part Markings (Top View)**



**Figure 9. SKY66104-11 PCB Layout Footprint**

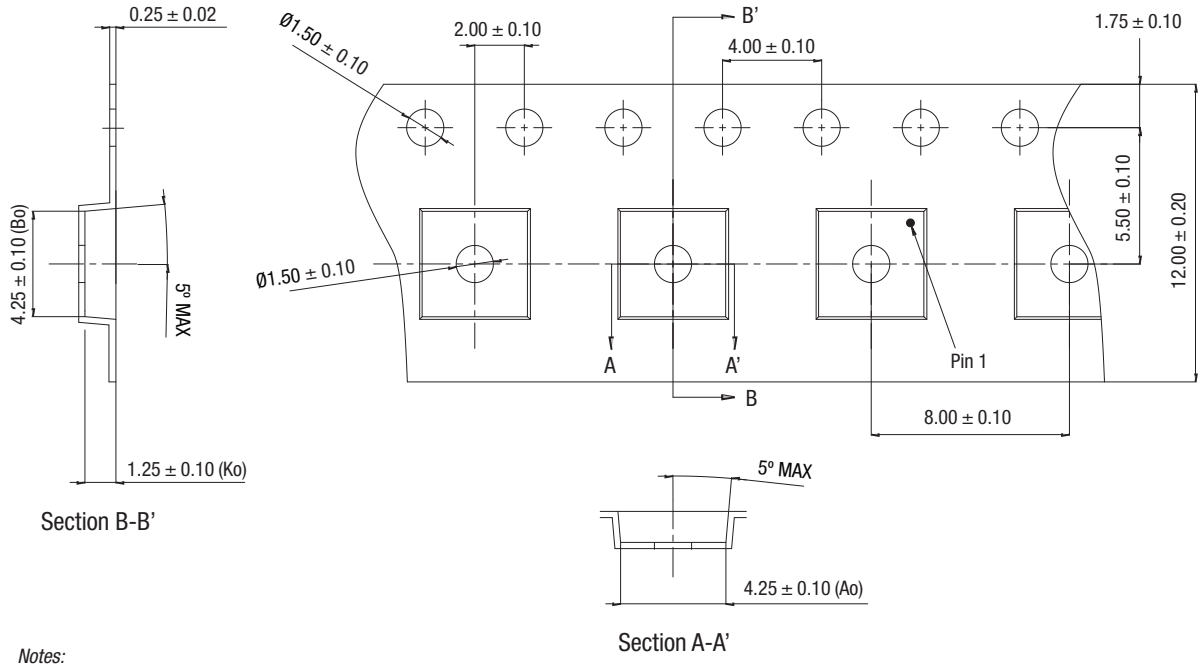
All measurements are in millimeters

S3563



S3560

Figure 10. SKY66104-11 24-Pin MCM Package Dimensions



- Notes:
1. All measurements are in millimeters.
  2. Carrier tape must meet all requirements of Skyworks GP01-D232 procurement Spec for tape and reel shipping.
  3. Carrier tape shall be black conductive polycarbonate.
  4. Cover tape shall be transparent conductive material.
  5. ESD-surface resistivity shall meet GP01-D232.
  6. 10 sprocket hole pitch cumulative tolerance: ±0.20 mm.
  7. Ao and Bo measured on plane 0.30 mm above the bottom of the sprocket.
  8. Part No. : KS-1208-440-PC. (Please indicate on purchase order)

ts269

Figure 11. SKY66104-11 Tape and Reel Dimensions

## Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY66104-11: RF Front-End Module	SKY66104-11	SKY66104-11-EK1

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